

SDM20E40C

DUAL SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary

V _{RRM} (V)	I _{FM} (A)	V _F Max (V)	I _R Max (μA) @ 25V
40	0.4	0.50	70

Description and Applications

This Schottky Barrier Diode is designed for low forward voltage drop and very low reverse leakage current. It is ideally suited to use as:

- Polarity Protection Diode
- Re-Circulating Diode
- Switching Diode

Features

- Very Low Forward Voltage Drop
- Common Cathode Configuration
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

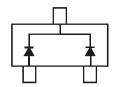
Mechanical Data

- Case: SC59
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)

SC59



Top View



Device Schematic

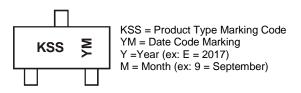
Ordering Information (Note 4)

Part Number	Case	Packaging
SDM20E40C-7-F	SC59	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



Date Code Key

Year		2015	2016	2017	20	18	2019	2020	2021	20	22	2023
Code		С	D	Е	F	=	G	Н	I	,	J	K
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM V _R	40	٧
RMS Reverse Voltage	V _{R(RMS)}	28	V
Forward Continuous Current (Note 6)	I _{FM}	0.4	A
Non-Repetitive Peak Forward Surge Current @ t = 8.3ms	I _{FSM}	2	A
Repetitive peak Forward Current	I _{FRM}	500	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_{D}	400	mW
Typical Thermal Resistance Junction to Ambient Air (Note 6)	R _{0JA}	180	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	$R_{ heta JC}$	41	°C/W
Operating Temperature Range	T _{OP}	-30 to +85	°C
Junction Temperature Range	T_J	-30 to +125	°C
Storage Temperature Range	T _{STG}	-40 to +125	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	40			V	$I_R = 500\mu A$
Forward Voltage	VF	_	_	300	mv	$I_F = 10mA$
1 of ward voltage	٧F			500		$I_F = 200 \text{mA}$
Leakage Current (Note 5)	I_R			70	μΑ	$V_R = 25V$
Total Capacitance	Ст		_	100	pF	$V_R = 0V$, $f = 1.0MHz$

Notes:

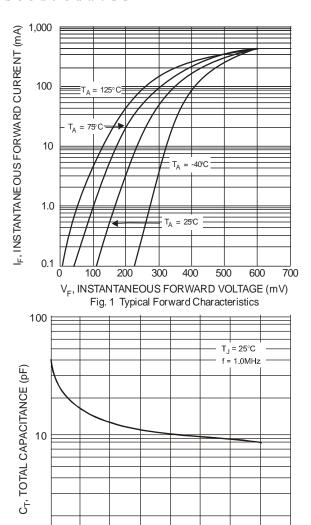
^{5.} Short duration pulse test used to minimize self-heating effect.6. Mounted on FR4 PC Board with minimum recommended pad layout which can be found on our website at http://www.diodes.com/package-outlines.html.

150

100

T_A, AMBIENT TEMPERATURE (°C) Fig. 4 Power Derating Curve





25

30

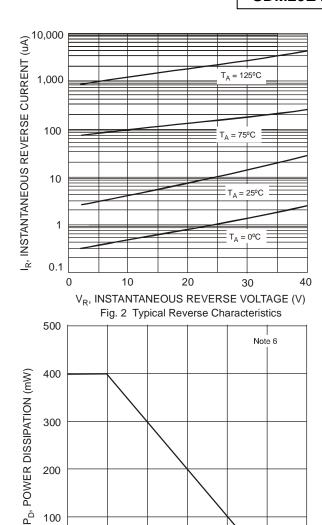
35

20

V_R, DC REVERSE VOLTAGE (V)

Fig. 3 Total Capacitance vs. Reverse Voltage

15



100

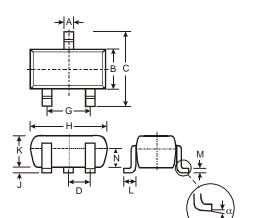
0

0



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

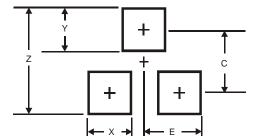


SC59

SC59							
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
В	1.50	1.70	1.60				
C	2.70	3.00	2.80				
D	-	-	0.95				
G	-	-	1.90				
H	2.90	3.10	3.00				
J	0.013	0.10	0.05				
K	1.00	1.30	1.10				
L	0.35	0.55	0.40				
M	0.10	0.20	0.15				
N	0.70	0.80	0.75				
α	0°	8°	-				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SC59

Dimensions	Value (in mm)
Z	3.4
Х	0.8
Y	1.0
С	2.4
E	1.35



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